

Bill of Materials

TI DESIGNS

TIDM-SERVER-PWR-MON

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
1	1	IPC		Printed Circuit Board		Printed Circuit Board			
2	1	C4	470nF	CAP, CERM, 470nF	Taiyo Yuden	EMK107F474ZA-T		0603	Digikey Product Page
3	1	R18	2.2k	RES, 2.2kohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ222V		0603	Digikey Product Page
4	1	R19	Open	RES, open ohm, x%, xW, [PackageReference]				0603	OPEN
5	1	R20	1k	RES, 1k ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ102V		0603	Digikey Product Page
6	1	R21	2.2k	RES, 2.2k ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ222V		0603	Digikey Product Page
7	1	R22	68	RES, 68 ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ680V		0603	Digikey Product Page
8	1	R23	1k	RES, 1k ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ102V		0603	Digikey Product Page
9	1	R24	10k	RES, 10k ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ103V		0603	Digikey Product Page
10	1	R25	1.5k	RES, 1.5k ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ152V		0603	Digikey Product Page
11	1	R26	220	RES, 220 ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ221V		0603	Digikey Product Page
12	4	C8, C9, C12, C13	47pF	CAP, CERM, 47pF, 50V, +/-5%, COG/NPO, 0402	Murata Electronics North America	GRM1555C1H470JZ01		0402	Digikey Product Page
13	2	C10, C14	0.015uF	CAP, CERM, 0.015uF, 50V, +/-10%, X7R, 0402	Murata Electronics North America	GRM155R71H153KA12D		0402	Digikey Product Page
14	2	C11, C20	0.1uF	CAP, CERM, 0.1uF, 10V, +/-10%, X5R, 0402	TDK Corporation	C1005X5R1A104K		0402	Digikey Product Page
15	1	C19	10uF	CAP, TANT, 10uF, 10V, +/-20%, 2.5 ohm, 3528-21 SMD	Vishay Sprague	293D106X0010B2TE3		3528-21	Digikey Product Page
16	1	C21	2.2n	CAP, CERM, 2.2nF, 25V, +/-10%, X7R, 0805	AVX Corporation	0805C222JAT2A		0805	Digikey Product Page
17	2	C24, C25	0.1uF	CAP, CERM, 0.1uF, 50V, +/-10%, X7R, 0603	TDK Corporation	C1608X7R1H104K		0603	Digikey Product Page
18	2	C26, C27	10uF	CAP, TANT, 10uF, 50V, +/-10%, 0.8 ohm, 7343-43 SMD	AVX Corporation	F931D106KAA		7343-43	Digikey Product Page
19	1	C28	220uF	CAP, TANT, 220uF, 6.3V, +/-10%, 0.6 ohm, 7343-31 SMD	AVX Corporation	TCJB227M006R0200		7343-31	Digikey Product Page
20	2	D1, D8			Littelfuse Inc	SMAJ5.0CA		DSO-C2X1.8	Digikey Product Page
21	4	D2, D3, D4, D5			Vishay Semiconductor Diodes Division	LL103A		SOD-80	Digikey Product Page
22	1	D6			Littelfuse Inc	V320SM7		V320SM7	Digikey Product Page
23	1	D7	7V	Diode, TVS, Uni, 7V, 600W, SMB	Diodes Incorporated	SMBJ7.0A-13-F		SMB	Digikey Product Page
24	1	FR		Fuse, 1A,125V, SMD	Cooper Bussmann	6125FA1A		6125FA	Digikey Product Page
25	4	H1, H2, H3, H4		Machine Screw, Round, #4-40 x 1/4, Nylon, Philips panhead		NY PMS 440 0025 PH		NY PMS 440 0025 PH	Not populated
26	4	H5, H6, H7, H8		Standoff, Hex, 0.5"L #4-40 Nylon		1902C		Keystone, 1902C	Not populated
27	1	J1				LIVE_IN		Hole for Banana Socket	N/A (3.5mm diameter through hole only, no component populated)
28	1	J2				LIVE_OUT		Hole for Banana Socket	N/A (3.5mm diameter through hole only, no component populated)
29	1	J3				NEUTRAL_IN		Hole for Banana Socket	N/A (3.5mm diameter through hole only, no component populated)
30	1	J4				NEUTRAL_OUT		Hole for Banana Socket	N/A (3.5mm diameter through hole only, no component populated)
31	1	J5		Header, TH, 100mil, 2x2, Gold plated, 230 mil above insulator	TE Connectivity	TSW-102-07-G-D		TSW-102-07-G-D	Digikey Product Page
32	1	J6			Sullins Connector Solutions	1.27mm pitch socket		6-pin header (1.27mm)	Digikey Product Page
33	1	J7		Receptacle Assembly, 9 Position, Right Angle	TE Connectivity	D Connector 9		DSUB1 385-2H9	Digikey Product Page
34	1	J8	1x3	Header, TH, 100mil, 1x3, Gold plated, 230 mil above insulator	Sullins Connector Solutions	PBC03SAAN		PBC03SAAN	Digikey Product Page
35	1	J9		Header, 4-Pin 100mil 1x4	TE Connectivity	Header 4		A31114-ND	Digikey Product Page
36	2	L1, L2		Inductor, [Technology], [Material], xxuH, xxA, x.xx ohm, [MountType]	Murata Electronics North America	BLM21BD121SN1D		0805	Digikey Product Page
37	1	LBL1		Thermal Transfer Printable Labels, 0.650" W x 0.200" H - 10,000 per roll		Size: 0.65" x 0.20"		Label 650x200	Not populated
38	2	LED1, LED5		Red	Lite-On Inc	LTST-C170KRKT		0805-LED	Digikey Product Page
39	2	LED2, LED6		Green	Lite-On Inc	LTST-S220KGKT		0805-LED	Digikey Product Page
40	2	LED3, LED7		Blue	Lite-On Inc	LTST-C170TBKT		0805-LED	Digikey Product Page
41	1	LED4		White	Lite-On Inc	LTV-170TK		0805-LED	Digikey Product Page
42	1	F1		Header, 7-Pin, Dual row	TE Connectivity	A104860-ND		2X7BOXHEADER	Digikey Product Page
43	2	Q1, Q2	0.075V	Transistor, PNP, 45V, 0.1A, SOT-23	Micro Commercial Co	BC857B		SOT-23	Digikey Product Page
44	3	R1, R13, R14	330k	RES, 330kohm, 1%, 1W, 2010, RES, 330kohm, 5%, 1W, 2010	Panasonic Electronic Components	ERJ-S1DF3303U		2010M	Digikey Product Page
45	1	R15	1.5k	RES, 1.5kohm, 1%, 1W, 2010, RES, 330kohm, 5%, 1W, 2010	Rohm Semiconductor	MCR60JZH1501		2010M	Digikey Product Page
46	7	R2, R3, R4, R5, R7, R12, R17	390	RES, 390 ohm, 5%, 0.125W, 0805	Panasonic Electronic Components	ERJ-3GEYJ391V		0805	Digikey Product Page
47	1	R6	500u-ohm	Shunt Resistor	INTERNATIONAL RESISTIVE	ULRB12512R0005FLSFL		Current Sensing Pad	International Resistive Product Page
48	3	R8, R9, R11	1.00k	RES, 1.00k ohm, 1%, 0.063W, 0402	Vishay Dale	CRCW04021K00FKED		0402	Digikey Product Page
49	1	R10	100	RES, 100 ohm, 1%, 0.063W, 0402	Vishay Dale	CRCW0402100RFKED		0402	Digikey Product Page
50	1	R16	47k	RES, 47k ohm, 5%, 0.063W, 0402	Vishay Dale	CRCW040247K0JNED		0402	Digikey Product Page
51	7	R27, R28, R29, R30, R31, R36, RA3	Open	RES, open ohm, x%,		Open		0805	OPEN
52	1	R32	1.5k	RES, 1.5k ohm, x%,	Panasonic Electronic Components	ERJ-3GEYJ152V		0805	Digikey Product Page
53	1	R33	1.5k	RES, 1.5k ohm, x%,	Panasonic Electronic Components	ERJ-3GEYJ152V		0805	Digikey Product Page
54	1	R35	OR	RES, 0 ohm, x%,	Panasonic Electronic Components	ERJ-3GEYR000V		0805	Digikey Product Page
55	1	R34	330	RES, 330 ohm, x%, xW, [PackageReference]	Panasonic Electronic Components	ERJ-3GEYJ331V		0402	Digikey Product Page
56	1	U1		MSP430I2040	Texas Instruments	MSP430I2040PW		TSSO10x6-G28	

Item	Qty	Reference	Value	Part Description	Manufacturer	Manufacturer Part Number	Alternate Part	PCB Footprint	Note
57	2	U2, U3		PS8802-1	CEL	PS8802-1		SO-8	Digikey Product Page
58	1	U4		On board block power supply	CUI Inc	VSK-S1-3R3U		VSK-S1	Digikey Product Page

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